

06-15-2004

FORM PTO-1595
1-31-92U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

DOCKET NO. 2336-297

102766285

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereto:

1. Name of conveying party(ies):

1. Ki Young LEE

6.8.04

2. Name and address of receiving party(ies):

Name: Samsung Electro-Mechanics Co., Ltd.

Street Address: 314 Maetan-3-dong, Youngtong-ku

City: Kyungki-do, Suwon

Country: Republic of Korea

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: May 28, 2004

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

10862352

If the document is being filed together with a new application, the execution date of the application is: May 28, 2004

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name:

LOWE HAUPTMAN GILMAN & BERNER

Internal Address:

Street Address: 1700 Diagonal Road, Suite 300

City: Alexandria

State: VA

Zip: 22314

6. Total number of applications and patents involved: one7. Total fee (37 CFR 3.41) \$ 40.00☐ Enclosed☐ Authorized to be charged to deposit account☒ Credit Card payment form enclosed

8. Deposit account number: 07-1337

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9. Signature.

Benjamin J. Hauptman, 29,310

Name of Person, Registration No.

Signature

June 8, 2004

Date

Total number of pages including cover sheet, attachment, and document:

3

CMB No. 0851-0011 (exp. 4/94)

19587 U.S. PTO
10/862352

060804

06/09/2004 HTECKLU1 00000070 10862352

04 FC:8021

40.00 OP

PATENT
REEL: 015445 FRAME: 0029

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>LEE, Ki Young</u>	(4) _____
(2) _____	(5) _____
(3) _____	(6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG ELECTRO-MECHANICS CO., LTD.
314 Maetan-3-dong, Youngtong-ku,
Suwon, Kyungki-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled AUTOMATIC SLIDING-TYPE MOBILE COMMUNICATION TERMINAL, METHOD OF AUTOMATICALLY DRIVING SLIDING-TYPE MOBILE COMMUNICATION TERMINAL, AND METHOD OF DETECTING INCOMING CALL TO SLIDING-TYPE MOBILE COMMUNICATION TERMINAL

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____;

or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the

undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTOR(S)

DATE SIGNED

1) 
Name: LEE, Ki Young

May 28, 2004